

# **MOSFET**

# **StrongIRFET™ 2 Power-Transistor**

#### **Features**

- Optimized for a wide range of applications
- N-channel, normal level100% avalanche tested

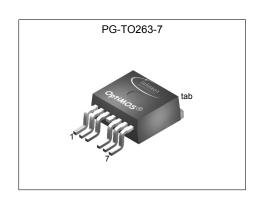
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

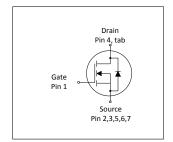
#### **Product validation**

Qualified according to JEDEC Standard

Table 1 **Key Performance Parameters** 

Parameter	Value	Unit
V <sub>DS</sub>	60	V
R <sub>DS(on), max</sub>	1.7	mΩ
$I_D$	223	A
Qoss	108	nC
Q <sub>G</sub> (0V10V)	108	nC











Type / Ordering Code	Package	Marking	Related Links
IPF016N06NF2S	PG-TO263-7	016N06NS	-

# StrongIRFET<sup>TM</sup> 2 Power-Transistor



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## StrongIRFET<sup>™</sup> 2 Power-Transistor IPF016N06NF2S



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	O h l		Value	s		N ( / T ( O )
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	-	223 171 35	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W <sup>2</sup> )
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	892	Α	T <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	349	mJ	$I_D$ =100 A, $R_{GS}$ =25 Ω
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	188 3.8	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =40 °C/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	-

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Offic	Note / Test Condition
Thermal resistance, junction - case	<b>R</b> thJC	-	-	0.8	°C/W	-
Thermal resistance, junction - Ambient, 6 cm² cooling area²)	R <sub>thJA</sub>	_	-	40	°C/W	-
Thermal resistance, junction - Ambient	R <sub>thJA</sub>	-	-	62	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

# StrongIRFET<sup>™</sup> 2 Power-Transistor IPF016N06NF2S



### **Electrical characteristics**

at T<sub>j</sub>=25 °C, unless otherwise specified

**Static characteristics** Table 4

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	2.1	2.8	3.3	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =129 μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.5 10	1 100	μΑ	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	1.3 1.8	1.7 2.5	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =100 A V <sub>GS</sub> =6 V, I <sub>D</sub> =50 A
Gate resistance	R <sub>G</sub>	-	2.7	-	Ω	-
Transconductance <sup>1)</sup>	<b>g</b> fs	110	-	-	S	V <sub>DS</sub>   ≥2   I <sub>D</sub>   R <sub>DS(on)max</sub> , I <sub>D</sub> =100 A

Table 5 **Dynamic characteristics** 

Davamatar	Cumbal	Values			11:4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	7300	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Output capacitance	Coss	-	1550	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Reverse transfer capacitance	C <sub>rss</sub>	-	63	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	22	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$
Rise time	t <sub>r</sub>	-	31	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	48	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$
Fall time	t <sub>f</sub>	-	17	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Parameter	Cymah al	Values			Unit	Note / Tost Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	33	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	Q <sub>g(th)</sub>	-	20	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	Q <sub>gd</sub>	-	20	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	33	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	108	162	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	4.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	100	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge	Qoss	-	108	-	nC	V <sub>DD</sub> =30 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

# StrongIRFET<sup>TM</sup> 2 Power-Transistor IPF016N06NF2S

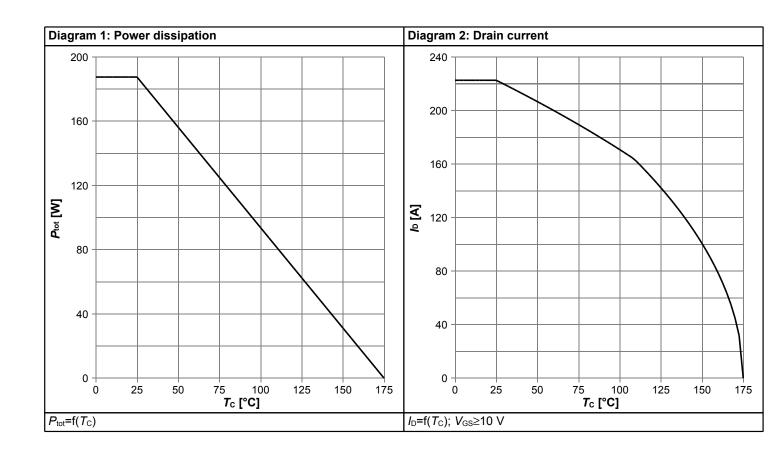


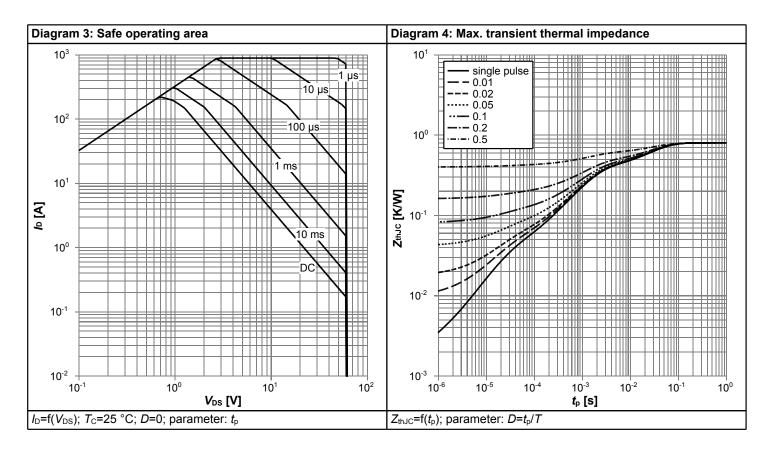
### Table 7 Reverse diode

Paramatan.	Complete		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	171	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	892	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.88	1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =100 A, T <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	34	-	ns	V <sub>R</sub> =30 V, I <sub>F</sub> =100 A, di <sub>F</sub> /dt=500 A/μs	
Reverse recovery charge	Qrr	-	169	-	nC	$V_R$ =30 V, $I_F$ =100 A, $di_F/dt$ =500 A/ $\mu$ s	

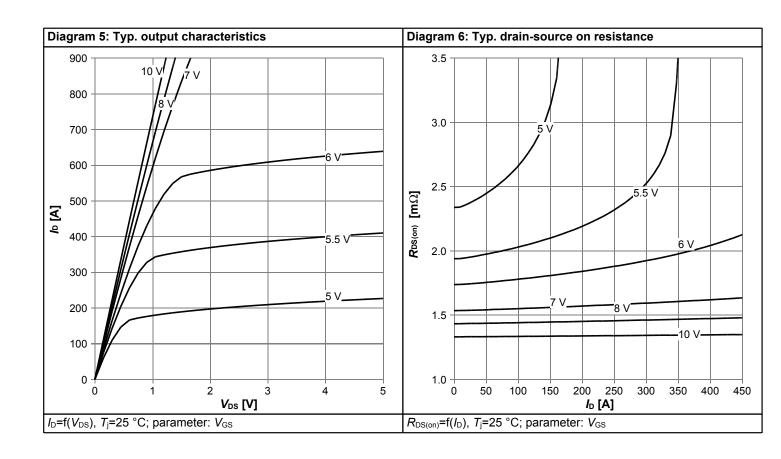


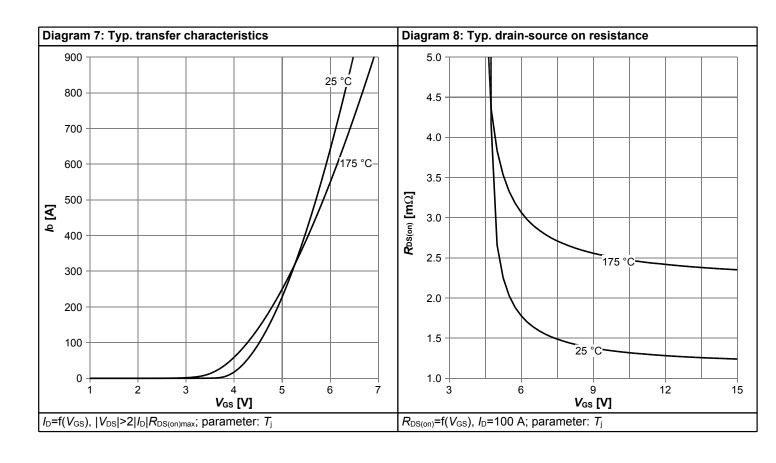
# 4 Electrical characteristics diagrams



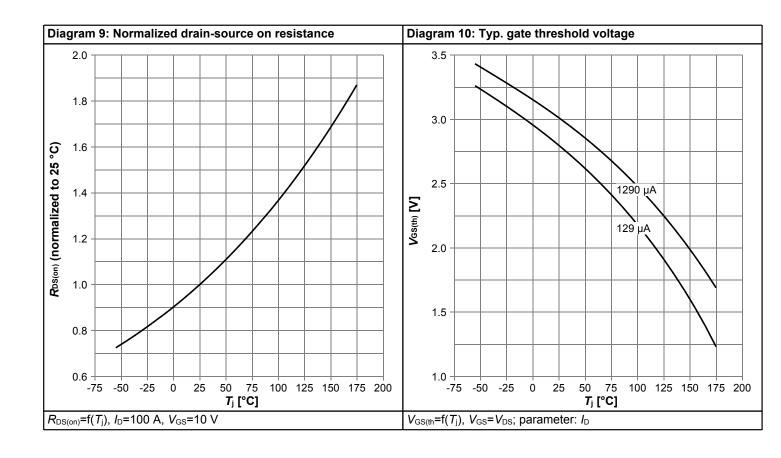


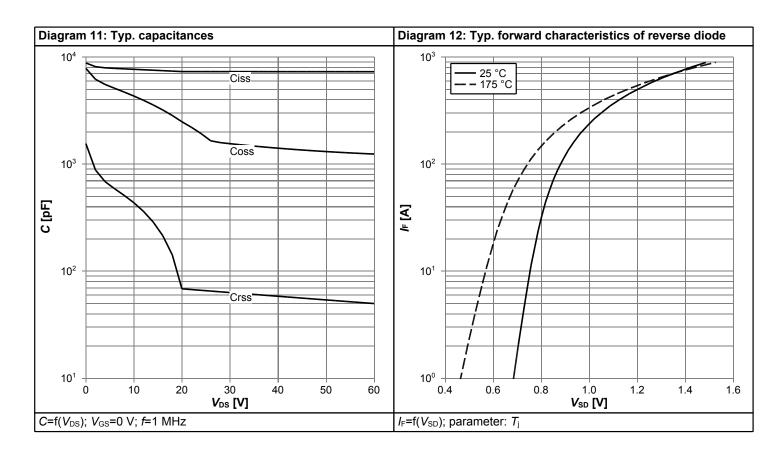




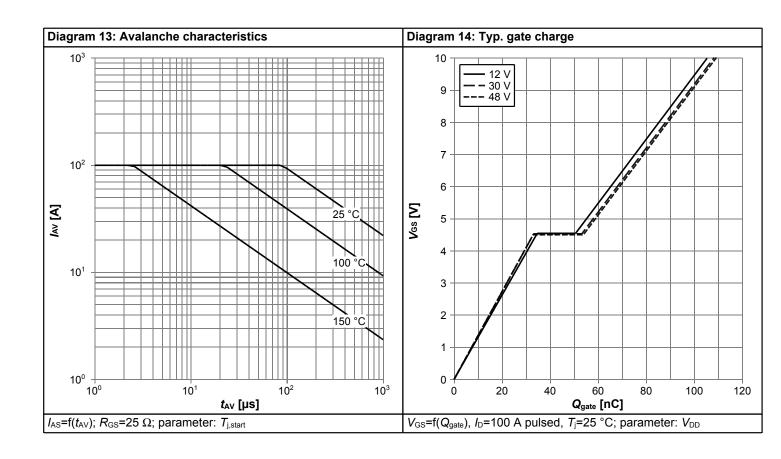


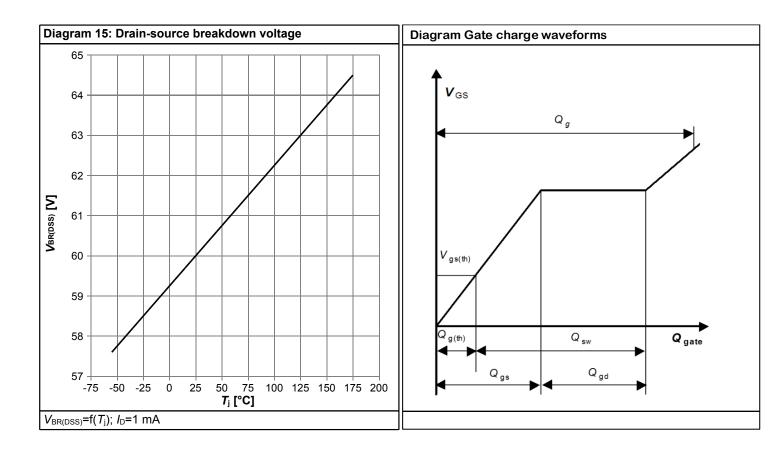






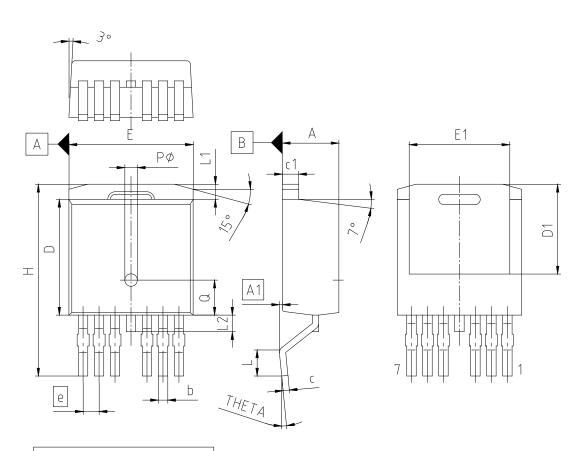








# 5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TO2	63-7-U02				
DIMENSIONS	MILLIN	METERS				
DIMENSIONS	MIN.	MAX.				
Α	4.30	4.70				
A1	0.00	0.25				
b	0.65	0.85				
С	0.45	0.60				
c1	1.25	1.40				
D	9.00	9.40				
D1	6.86	7.42				
E	9.68	10.08				
E1	7.70	8.30				
е	1.27					
N	7					
Н	14.61	15.88				
L	1.78	2.79				
L1	0.00	1.60				
L2	0.00	1.78				
THETA	0° - 8°					
PØ	0.90	1.10				
Q	2.78					

Figure 1 Outline PG-TO263-7, dimensions in mm

# StrongIRFET<sup>™</sup> 2 Power-Transistor IPF016N06NF2S



#### **Revision History**

IPF016N06NF2S

Revision: 2022-10-19, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2022-10-19	Release of final version			

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Final Data Sheet 11 Rev. 2.0, 2022-10-19